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EFS ID: 17520
Application ID: 10040945
Title of Invention: Modular assembly of antibody
genes, antibodies prepared
thereby and use
First Named Inventor: Randy Robinson
Domestic/Foreign Application: Domestic Application
Filing Date: 2002-08-29
Effective Receipt Date: 2002-08-29 
Submission Type: Information Disclosure Statement
Filing Type: null
Confirmation Number: 5282
Attorney Docket Number: 0610.0050001
Digital Certificate Holder: cn=Michele A. Cimbala, ou=Registered Attorneys, ou=Patent and
Trademark Office, ou=Department of Commerce, o=U.S.
Government, c=US
Certificate Message Digest: YAyirI84u61pLlqwv4/M6Q==



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Electronic Version 1.0.3

Application Number: 10/040,945

Stylesheet Version: 1.0

Attorney Docket Number: 0610.0050001

Submission Type: Information

Disclosure Statement

Modular assembly of antibody genes, antibodies prepared thereby and use

First Named Inventor: Randy R. Robinson

SUBMITTED BY

Name: Michele Cimbala

Registration Number: 33,851

Electronic Signature Mark: mcimbala Date Signed: 20020829

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Attached Files:

us-information-disclosure-statement

IDS0610005000lids.xml

Comments:



Electronic Information Disclosure Statement

Modular assembly of antibody genes, antibodies prepared thereby and use

Application:



10/040945

Confirmation: 5282

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Applicant(s): Randy Robinson

TECH CENTER 1600/2900

Docket Number: 0610.0050001

Group Art

Unit:

Examiner:

search string: (4338397 or 4642334 or 4656134 or 4816397 or 4816567 or 4935496 or 4963495 or 5576195 or 5595898 or 5618920 or 5648237 or 5693493 or 5698417 or 5698435 or 5846818 or 6204023 or 6331415).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Citation No.	Patent Number	Date	Bar Code	Patentee	Class	Subclass
	P01	4338397	1982-07-06		Gilbert et al.	435	68
	P02	4642334	1987-02-10		Moore et al.	530	388
	P03	4656134	1987-04-07		Ringold	435	91
	P04	4816397	1989-03-28		Boss et al.	435	68
	P05	4816567	1989-03-28		Cabilly et al.	530	387
	P06	4935496	1990-06-19		Kudo et al.	530	388
	P07	4963495	1990-10-16		Chang et al.	435	320

P08	5576195	1996-11-19		Robinson et al.	435	69.8
P09	5595898	1997-01-21		Robinson et al.	435	172.3
P10	5618920	1997-04-08		Robinson et al.	530	387.1
P11	5648237	1997-07-15		Carter	435	69.1
P12	5693493	1997-12-02		Robinson et al.	435	69.1
P13	5698417	1997-12-16		Robinson et al.	435	69.1
P14	5698435	1997-12-16		Robinson et al.	435	240.2
P15	5846818	1998-12-08		Robinson et al.	435	320.1
P16	6204023	2001-03-20		Robinson et al.	435	71.3
P17	6331415	2001-12-18		Cabilly et al.	435	69.6

Signature

Examiner Name	Date